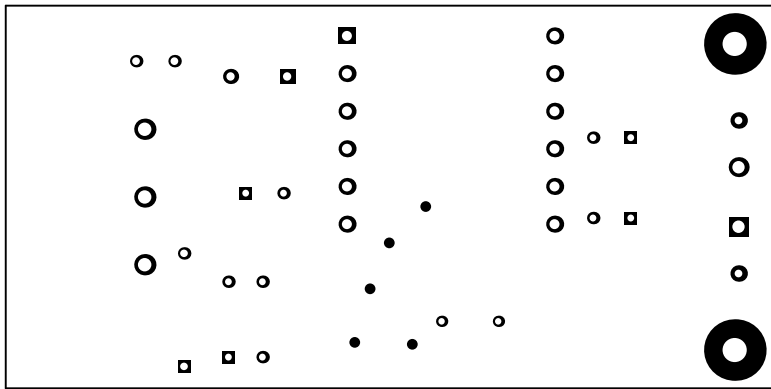
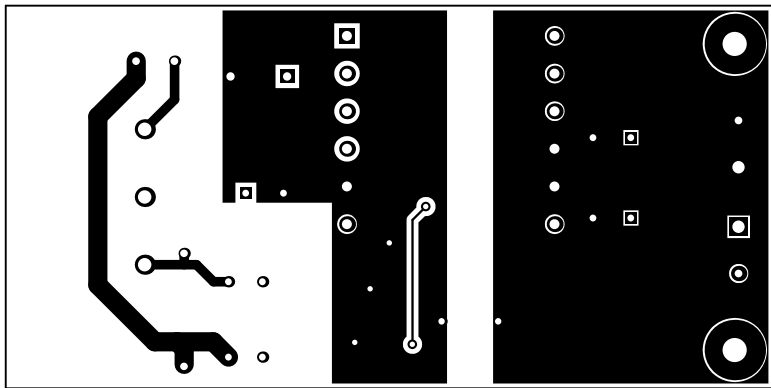


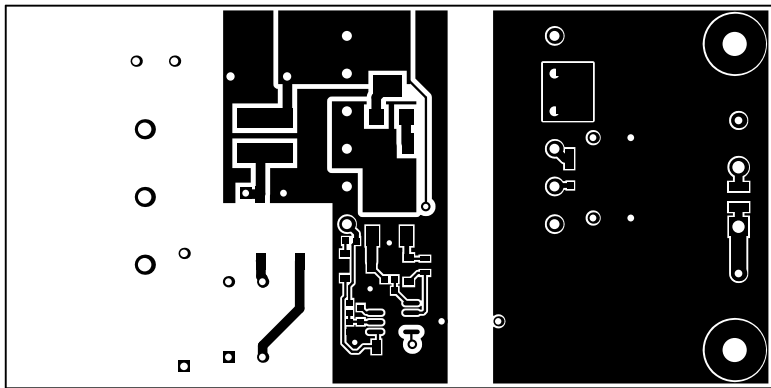
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9576	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 2/4/2014 7:27:09 AM	TEXAS INSTRUMENTS	



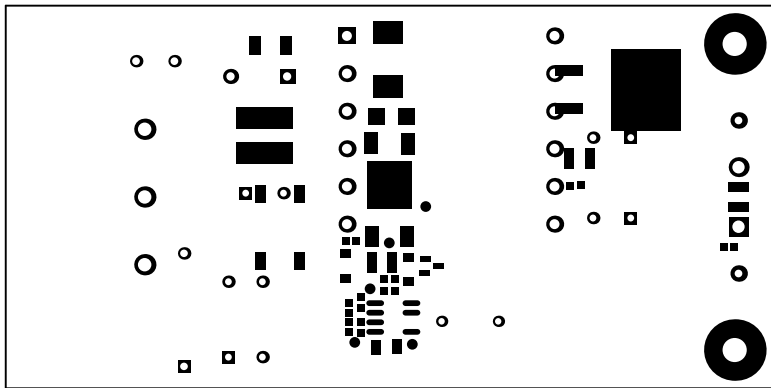
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9576	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 2/4/2014 7:27:10 AM	TEXAS INSTRUMENTS	



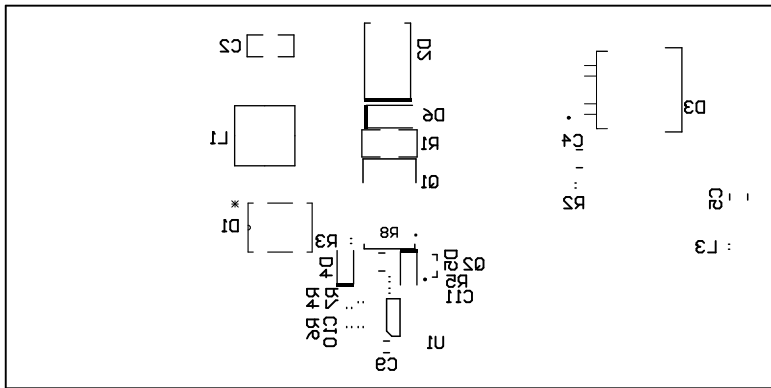
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9576	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 2/4/2014 7:27:10 AM	TEXAS INSTRUMENTS	



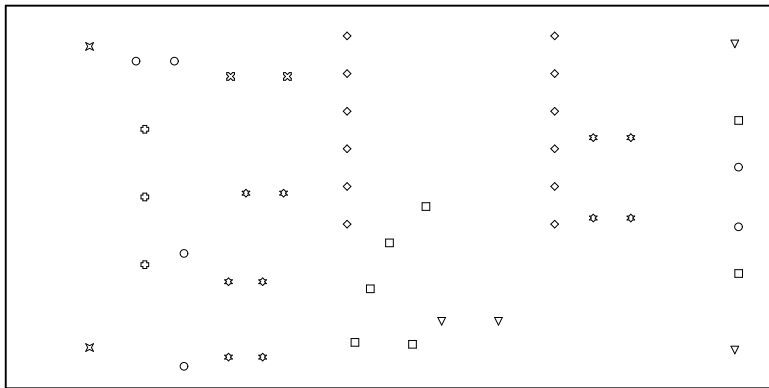
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9576	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 2/4/2014 7:27:11 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9576	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 2/4/2014 7:27:12 AM	TEXAS INSTRUMENTS	



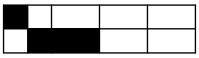
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9576	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 2/4/2014 7:27:13 AM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
□	5	28mil (0.711mm)	PTH	Round
▽	2	33.465mil (0.85mm)	PTH	Round
✱	10	35.433mil (0.9mm)	PTH	Round
○	4	39.37mil (1mm)	PTH	Round
□	2	40mil (1.016mm)	PTH	Round
✱	2	43.307mil (1.1mm)	PTH	Round
◇	12	52mil (1.321mm)	PTH	Round
○	2	64.961mil (1.65mm)	PTH	Round
⊕	3	70mil (1.778mm)	PTH	Round
▽	2	125.984mil (3.2mm)	PTH	Round
✱	2	137.795mil (3.5mm)	NPTH	Round
	46 Total			

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9576	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 2/4/2014 7:27:13 AM	TEXAS INSTRUMENTS	



← 1000 (mil) →

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9576	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 2/4/2014 7:27:14 AM	TEXAS INSTRUMENTS	

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